

# **TOSHIBA**    **PCB description - TC78H660FTG -**

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TC78H670FTG and TC78H660FTG are the same packages.

Therefore, it is possible to use PCB of TC78H670FTG as PCB of TC78H660FTG.

Although gerber data in this folder are for TC78H670FTG, it is possible to use for TC78H660FTG.

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